

## PPAK5X6 Pin Configuration

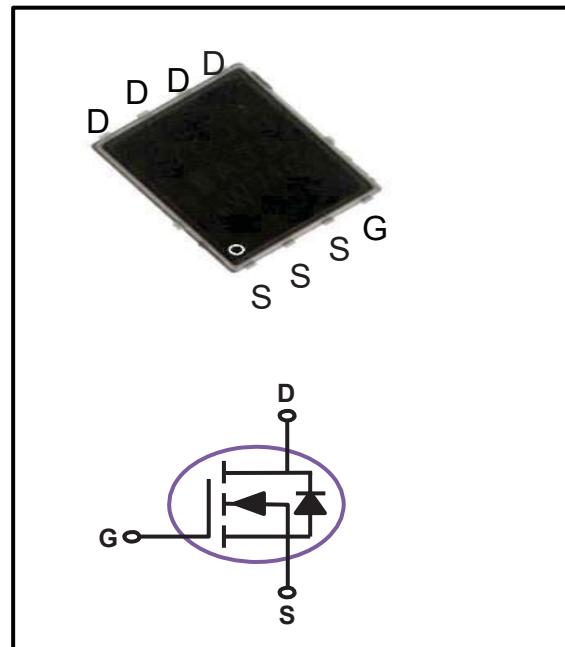
BVDSS	RDS(ON)	ID
100V	16.5mΩ	45A

### Features

- 100V, 45A, RDS(ON) = 16.5mΩ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Networking
- Load Switch
- LED applications



## MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current – Continuous (T <sub>c</sub> =25°C)	I <sub>D</sub>	45	A
Drain Current – Continuous (T <sub>c</sub> =100°C)		28.5	A
Drain Current – Pulsed <sup>1</sup>	I <sub>DM</sub>	180	A
Single Pulse Avalanche Energy <sup>2</sup>	EAS	72	mJ
Single Pulse Avalanche Current <sup>2</sup>	I <sub>AS</sub>	38	A
Power Dissipation (T <sub>c</sub> =25°C)	P <sub>D</sub>	83	W
Power Dissipation – Derate above 25°C		0. 6	W/°C
Storage Temperature Range	T <sub>STG</sub>	-55 to 150 <sup>b</sup>	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R <sub>θJA</sub>	---	62	°C/W
Thermal Resistance Junction to Case	R <sub>θJC</sub>	---	1.51	°C/W

**MOSFET ELECTRICAL CHARACTERISTICS**  $T_A = 25^\circ C$  unless otherwise specified

**Off Characteristics**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	100	---	---	V
Drain-Source Leakage Current	$I_{DS}$	$V_{DS}=80V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	$\mu A$
		$V_{DS}=80V, V_{GS}=0V, T_J=85^\circ C$	---	---	10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	$nA$

**On Characteristics**

Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=15A$	---	13.7	16.5	$m\Omega$
		$V_{GS}=4.5V, I_D=12A$	---	18	23	$m\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.6	2.5	V
Forward Transconductance	$g_f$	$V_{DS}=10V, I_D=3A$	---	7	---	S

**Dynamic and switching Characteristics**

Total Gate Charge <sup>3,4</sup>	$Q_g$	$V_{DS}=50V, V_{GS}=10V, I_D=20A$	---	14.5	22	nC
Gate-Source Charge <sup>3,4</sup>	$Q_{gs}$		---	1.5	3	
Gate-Drain Charge <sup>3,4</sup>	$Q_{gd}$		---	4.8	7.5	
Turn-On Delay Time <sup>3,4</sup>	$T_{d(on)}$	$V_{DD}=50V, V_{GS}=10V, R_G=6\Omega, I_D=20A$	---	4.8	7.2	ns
Rise Time <sup>3,4</sup>	$T_r$		---	12.5	19	
Turn-Off Delay Time <sup>3,4</sup>	$T_{d(off)}$		---	27.6	42	
Fall Time <sup>3,4</sup>	$T_f$		---	8.2	13	
Input Capacitance	$C_{iss}$		---	850	1300	pF
Output Capacitance	$C_{oss}$	$V_{DS}=50V, V_{GS}=0V, F=1MHz$	---	190	285	
Reverse Transfer Capacitance	$C_{rss}$		---	6.5	10	
Gate resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	---	0.9	---	$\Omega$

**Drain-Source Diode Characteristics and Maximum Ratings**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_s$	$V_G=V_D=0V$ , Force Current	---	---	45	A
Pulsed Source Current	$I_{SM}$		---	---	90	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_s=1A, T_J=25^\circ C$	---	---	1	V
Reverse Recovery Time	$t_{rr}$	$V_R=100V, I_s=10A$	---	140	---	ns
Reverse Recovery Charge	$Q_{rr}$	$di/dt=100A/\mu s, T_J=25^\circ C$	---	180	---	nC

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{DD}=50V, V_{GS}=10V, L=0.1mH, I_{AS}=38A, R_G=25 \Omega$  Starting  $T_J=25^\circ C$ .
- The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
- Essentially independent of operating temperature.

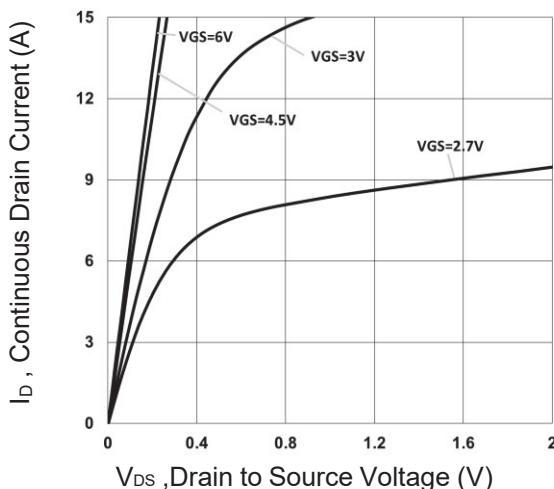


Fig.1 Typical Output Characteristics

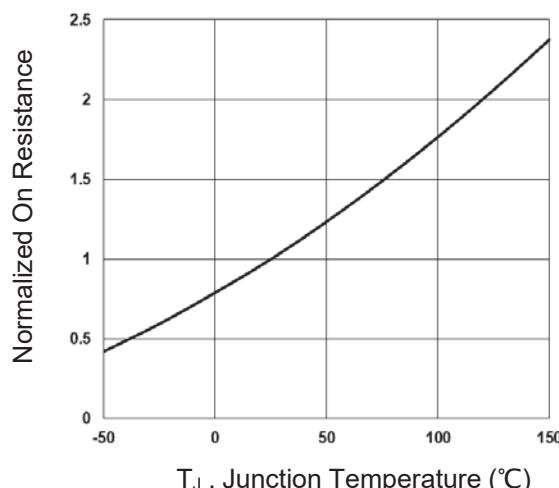


Fig.2 Normalized RDSON vs.  $T_J$

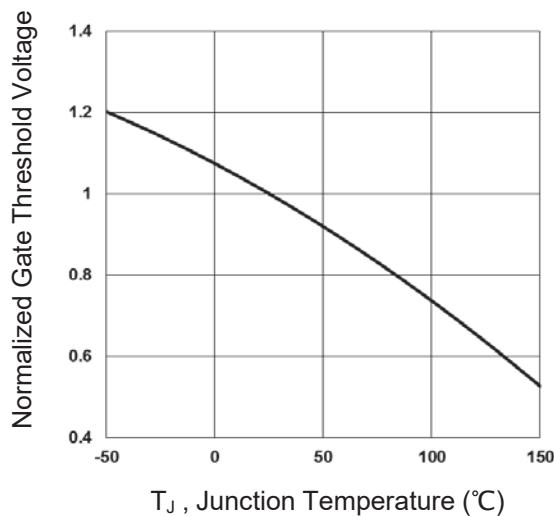


Fig.3 Normalized  $V_{th}$  vs.  $T_J$

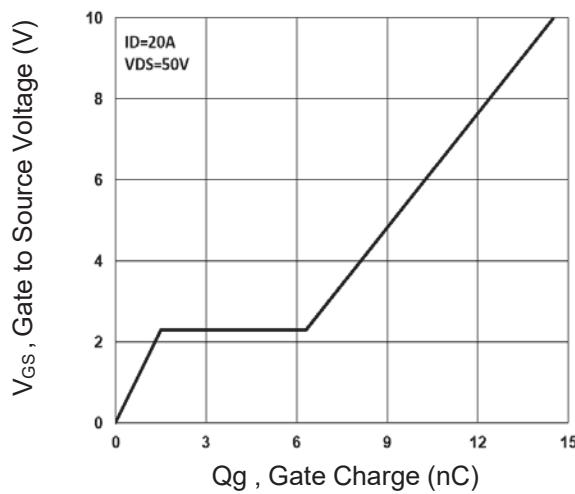


Fig.4 Gate Charge Waveform

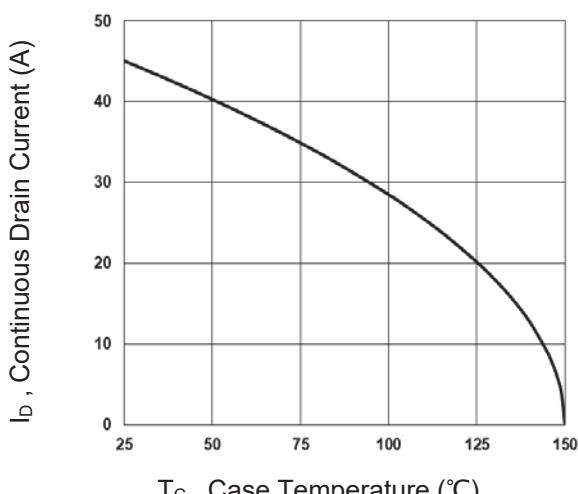


Fig.5 Continuous Drain Current vs.  $T_c$

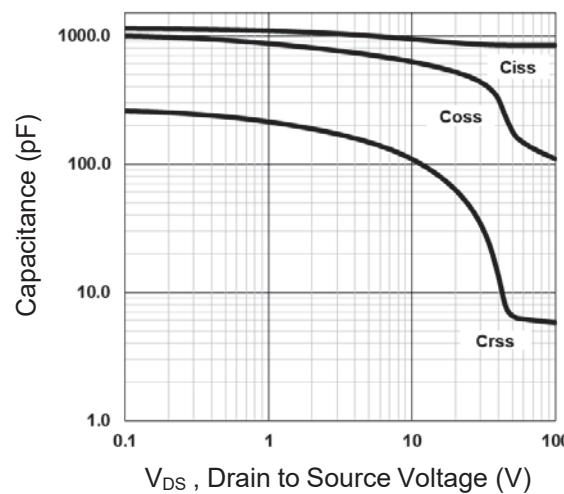
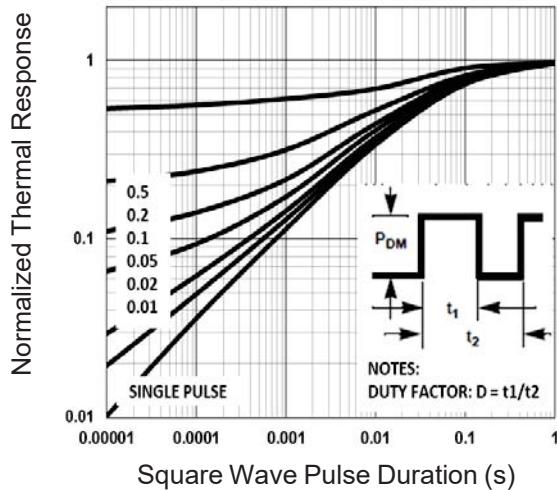
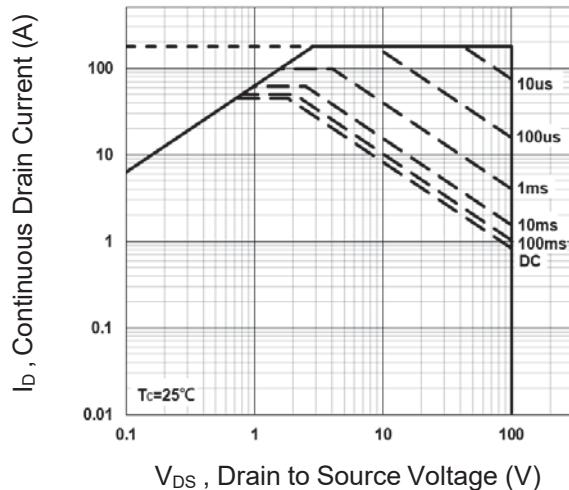
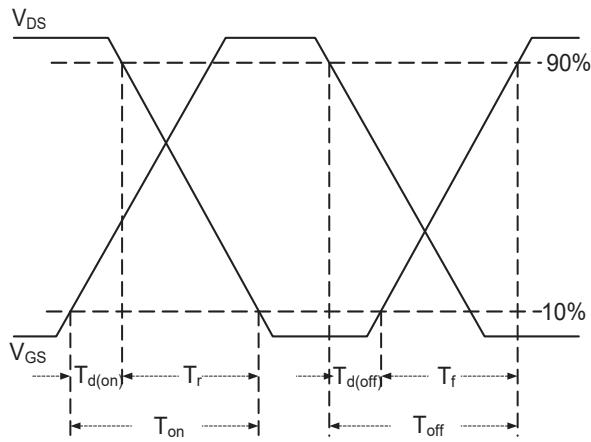
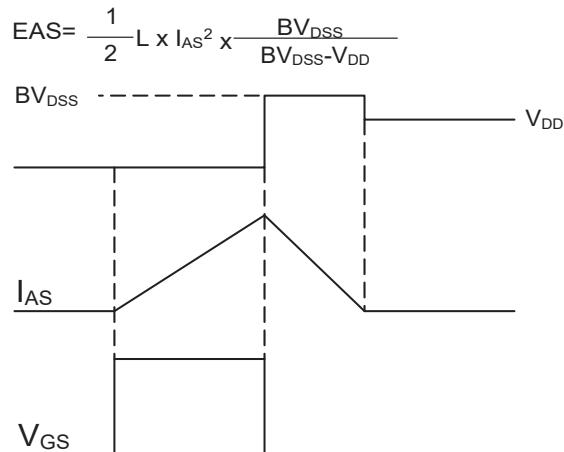
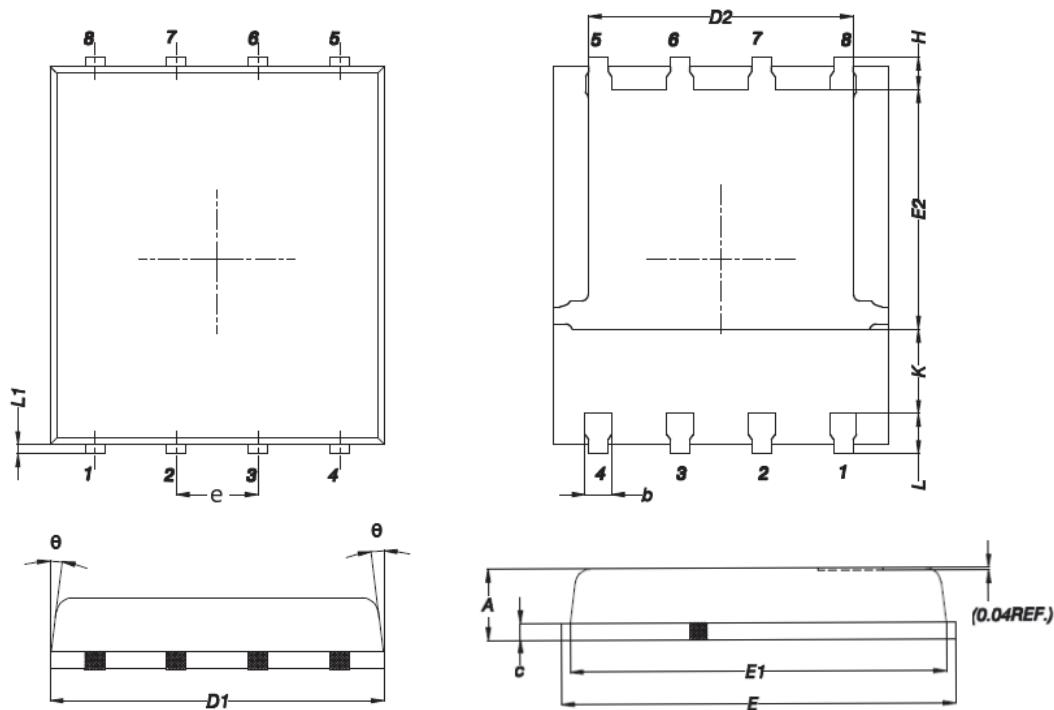


Fig.6 Capacitance Characteristics


**Fig.7 Normalized Transient Impedance**

**Fig.8 Maximum Safe Operation Area**

**Fig.9 Switching Time Waveform**

**Fig.10 EAS Waveform**

**PPAK5x6 PACKAGE INFORMATION**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.200	0.850	0.047	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.400	4.800	0.212	0.189
D2	4.310	3.610	0.170	0.142
E	6.300	5.850	0.248	0.230
E1	5.960	5.450	0.235	0.215
E2	3.920	3.300	0.154	0.130
e	1.27BSC		0.05BSC	
H	0.650	0.380	0.026	0.015
K	---	1.100	---	0.043
L	0.710	0.380	0.028	0.015
L1	0.250	0.050	0.009	0.002
θ	12°	0°	12°	0°